

Unapproved Meeting Minutes: IEEE 802.3 New Ethernet Applications Ad Hoc Interim Meeting

September 28, 2020

Telephonic

Prepared by John D'Ambrosia, Jon Lewis

Monday September 28, 2020

Meeting Chaired by John D'Ambrosia

Meeting called to order at approximately 10:03am ET.

Mr. D'Ambrosia reminded the group that attendance for this meeting would use IMAT.

Presentation #1 – General Information & Agenda

Presenter: John D'Ambrosia

URL: https://www.ieee802.org/3/ad_hoc/ngrates/public/calls/20_0928/agenda_nea_a_200928.pdf

Chair reviewed the meeting agenda and asked if there was any objection to approving the agenda as shown, none responded. Agenda was approved by unanimous consent.

Chair reviewed minutes for approval – Sep 14, 2020 Unapproved Minutes –

https://www.ieee802.org/3/ad_hoc/ngrates/public/calls/20_0914/minutes_nea_200914_unapproved.pdf

Chair asked if there were any objections to approving the modified minutes, as described, and there were no objections. The minutes were approved by unanimous consent.

Chair asked if anyone needed to review the IEEE-SA policies that the meeting is run by which were sent with the meeting invitation, none responded.

Mr. D'Ambrosia asked Mr. Lewis to chair meeting while he presented. Mr. Lewis started chairing meeting at 10:10 am.

Presentation #2 – Update - Draft CFI Consensus Deck - Beyond 400 GbE

Presenter – John D'Ambrosia

URL: https://www.ieee802.org/3/ad_hoc/ngrates/public/calls/20_0928/dambrosia_nea_01a_200928.pdf

General discussion and feedback about presentation.

Presentation #3 – Draft Call-for-Interest

Presenter – John D'Ambrosia

URL: https://www.ieee802.org/3/ad_hoc/ngrates/public/calls/20_0928/dambrosia_nea_02_200928.pdf

General discussion and feedback about the proposed CFI language. Text updated in

https://www.ieee802.org/3/ad_hoc/ngrates/public/calls/20_0928/dambrosia_nea_02a_200928.pdf.

D'Ambrosia resumed chairing meeting at ≈ 11:30am

Based on feedback to CFI Consensus Deck, D'Ambrosia noted an additional meeting to review the CFI Consensus deck would be organized.

D'Ambrosia reminded group of Oct 29, 2020 CFI Consensus building teleconference.

David Law, 802.3 WG Chair reviewed process issues related to the taking of strawpolls during the CFI Consensus Teleconference.

Mr. D'Ambrosia gave closing comments.

Meeting adjourned at ≈ 11:45 am.

Attendees

Name	Employer	Affiliation
Abbott, John	Corning Incorporated	Corning Incorporated
Bhatt, Vipul	Finisar Corporation	Finisar Corporation
Calvin, John	Keysight Technologies	Keysight Technologies
Carty, Clark	Cisco Systems, Inc.	Cisco Systems, Inc.
Chang, Yongmao	Inphi Corporation	Source Photonics
Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.
Choudhury, Golam	OFS	OFS
D'Ambrosia, John	Futurewei Technologies	Futurewei (U.S. Subsidiary of Huawei)
Dube, Kathryn	UNH-IOL	UNH-IOL
Ewen, John	Marvell	Marvell
Geng, Limin	HUAWEI	HUAWEI
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Inphi
Haser, Alexandra		Molex Incorporated
He, Xiang	HUAWEI	HUAWEI
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	Intel Corporation	Intel Corporation
Huber, Thomas	Nokia	Nokia
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co. Ltd
Jackson, Kenneth	Sumitomo Electric Device Innovations, USA	Sumitomo Electric Industries, LTD
Jimenez, Andrew	Anixter Inc.	Anixter Inc.
Johnson, John	Broadcom Limited	Broadcom Limited
Kabra, Lokesh	Synopsys, Inc.	Synopsys, Inc.
Kota, Kishore		Inphi Corporation
Lam, Cedric		Google
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Lewis, David	Lumentum Inc.	Lumentum Inc.
Lewis, Jon	Dell EMC	Dell EMC
Lingle, Robert	OFS	OFS
Mak, Gary		inphi
Malicoat, David	Malicoat Networking Solutions	Malicoat Networking Solutions; SENKO Advanced Components
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Marques, Flavio	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.
MASUDA, TAKEO	OITDA	OITDA
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
mi, guangcan	Huawei Technologies Co. Ltd	HUAWEI
Nering, Raymond	Cisco	Cisco Systems, Inc.
Nicholl, Shawn	Xilinx	Xilinx
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.
Omori, Kumi		NEC Corporation
Parsons, Earl	CommScope, Inc.	CommScope, Inc.

Pham, Phong	US Conec, Ltd.	US Conec, Ltd.
Piehler, David	Dell	Dell EMC
Powell, William	Nokia	INDEPENDENT
Pozzebbon, Dino	Microchip Technology, Inc.	Microchip Technology, Inc.
Ramesh, Sridhar	Maxlinear	Maxlinear Inc
Sambasivan, Sam	AT&T	AT&T
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
SAWANO, Hiroshi		OITDA
Shah, Anup	Mentor Graphics	Mentor Graphics
She, Qingya	Fujitsu Network Communications	Fujitsu Network Communications
Shukla, Priyank		Synopsys, Inc.
Sommers, Scott	Molex Incorporated	Molex Incorporated
Sone, Yoshiaki	NTT	Nippon Telegraph and Telephone Corporation (NTT)
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Sprague, Edward	Infinera Corporation	Infinera Corporation
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Stone, Robert	Broadcom Corporation	Broadcom Corporation
Swanson, John		Synopsys, Inc.
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LIMITED
Theodoras, James	HG Genuine	HG Genuine
Toyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.
Tracy, Nathan	TE Connectivity	TE Connectivity
Tran, Viet	Keysight Technologies	Keysight Technologies
Trowbridge, Stephen	Nokia	Nokia
Tsegaye, Tedros		Innolight Technology Corproation
Twombly, Jeff	Credo Semiconductor	Credo Semiconductor
Ulrichs, Ed	Source Photonics	Intel
Vanderlaan, Paul	UL LLC	UL LLC
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Weber, Markus	socionext	Acacia Communications
Wen, Yang	Huawei R&D USA	Huawei R&D USA
Williams, Tom	Acacia Communications	Acacia Communications
Withey, James	Fluke Corporation	Fluke Corporation
Young, James	CommScope, Inc.	CommScope
ZHANG, HUA		Hisense
Zhou, Xiang		Google
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.